Transistor

Small switching (-20V, -2.0A)

QS5U28

Features

- The QS5U28 conbines Pch Treueh MOSFET with a Schottky barrier diode in a single TSMT5 package.
- Pch Treueh MOSFET have a low on-state resisternce with a fast switching.
- 3) Pch Treueh MOSFET is neucted a low voltage drive (2.5V)
- 4) The independently connected Schottky barrier diode have a low forward voltage.

Applications

load switch, DC/DC conversion

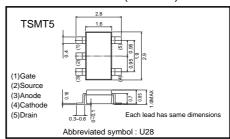
●Structure

- •Silicon P-channel MOS FET
- Schottky Barrier DIODE

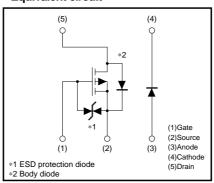
Packaging specifications

	Package	Taping	
Type	Code	TR	
,,	Basic ordering unit (pieces)	3000	
QS5U28		0	

●External dimensions (Unit:mm)



●Equivalent circuit



 A protection diode has been buitt in between the gate and the source to protect against static electricity when the product is in use. Use the protection circuit when rated voltages are exceeded.

●Absolute maximum ratings (Ta=25°C)

<MOSFET>

Parameter		Symbol	Limits	Unit		
Drain-source voltage		VDSS	-20	V		
Gate-source voltage		Vgss	±12	V		
Drain current	Continuous	lο	±2.0	Α		
	Pulsed	IDP	±8.0	A *1		
Source current	Continuous	Is	-1.0	Α		
(Body diode)	Pulsed	Isp	-8.0	A *1		
Channel temperature		Tch	150	°C		
Power dispation		PD	0.9	W/ELEMENT*3		
<di></di>						
Parameter		Symbol	Limits	Unit		
Repetitive peak reverse voltage		V _{RM}	25	V		
Reverse voltage		VR	20	V		
Forward current		lF	1.0	Α		
Forward current surge peak		IFSM	3.0	A *2		
Junction temperature		Tj	150	°C		
Power dispation		Po	0.7	W/ELEMENT*3		
<mosfet and="" di=""></mosfet>						
Parameter		Symbol	Limits	Unit		

PD

Tstg

1.25

-55 to +150

●Electrical characteristics (Ta=25°C)

<MOSFET>

Total power dispation

Range of strage temperature

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	
Gate-source leakage	Igss	-	_	±10	μΑ	Vgs= ±12V, Vps= 0V	
Drain-source breakdown voltage	V(BR) DSS	-20	-	-	٧	ID= -1mA, VGS= 0V	
Zero gate voltage drain current	IDSS	-	-	-1	μΑ	V _{DS} = -20V, V _{GS} = 0V	
Gate threshold voltage	VGS (th)	-0.7	-	-2.0	V	V _{DS} = −10V, I _D = −1mA	
Static drain-source on-starte resistance		ı	90	125	$m\Omega$	ID= -2A, VGS= -4.5V	
	RDS (on)	_	97	135	$m\Omega$	ID= -2A, VGS= -4.0V	
resistance		ı	175	245	$m\Omega$	ID= -1A, VGS= -2.5V	
Forward transfer admittance	Yfs	1.6	-	-	S	V _{DS} = -10V, I _D = -1A*	
Input capacitance	Ciss	ı	450	-	рF	Vps= -10V	
Output capacitance	Coss	-	70	-	pF	VGS= 0V	
Reverse transfer capacitance	Crss	-	52	-	pF	f=1MHz	
Tum-on delay time	td (on)	_	10	_	ns	V _{DD} ≒ –15V	
Rise time	tr	1	16	-	ns	Vgs= -4.5V Ip= -1A	
Tum-off delay time	td (off)	_	32	_	ns	ID= - IA RL≒15Ω	
Fall time	tr	-	15	-	ns	R _G = 10Ω	
Total gate charge	Qg	-	4.8	-	nC	V _{DD} = −15V V _{GS} = −4.5V	
Gate-source charge	Qgs	-	1.0	-	nC	I _D = -2A	
Gate-drain charge	Qgd	-	1.3	-	nC	R∟≒ 7.5Ω Rg= 10Ω	
<mosfet> Body diode (Source-drain)</mosfet>							
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp	ı	-	-1.2	٧	Is= -1.0V , Vgs= 0V

^{*} Pulsed

<Di>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	VF	-	-	0.45	V	Is= -1.0V
Reverse leakage	lr	-	-	200	μΑ	V _R = 20V

W/TOTAL *3

°С

^{*1} Pw≤10 μ s, Duty cycle≤1% *2 60Hz •1cyc. *3 Mounted on a ceramic board.

Electrical characteristic curves

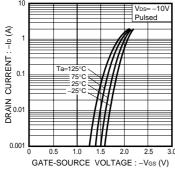


Fig.1 Typical Transfer Characteristics

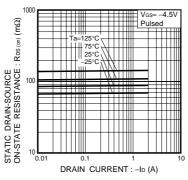


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current (I)

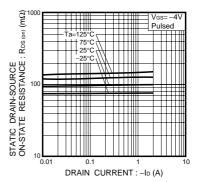


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current (II)

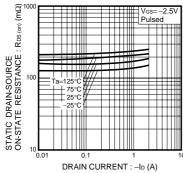


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current (III)

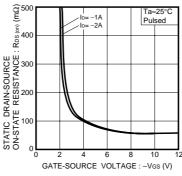


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

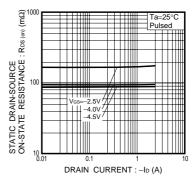


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current

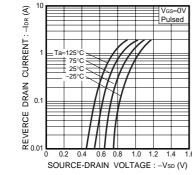


Fig.7 Reverse Drain Current vs. Source-Drain Voltage

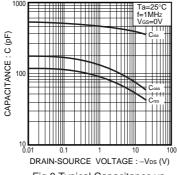


Fig.8 Typical Capacitance vs. Drain-Source Voltage

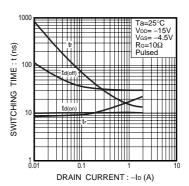


Fig.9 Switching Characteristics

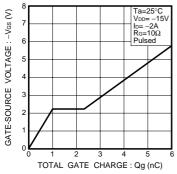


Fig.10 Dynamic Input Characteristics

Measurement circuits

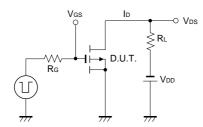


Fig.11 Switching Time Measurement Circuit

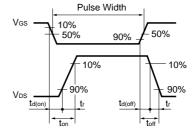


Fig.12 Switching Waveforms

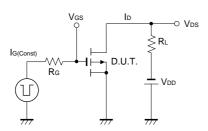


Fig.13 Gate Charge Measurement Circuit

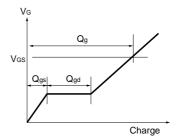


Fig.14 Gate Charge Waveforms

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